

Low Voltage and High Speed SPDT Analog Switch with True Isolation

Descriptions

The RLCS3457 is a single SPDT low on-resistance analog switch. It can operate from a single 1.5V to 5.5V power supply. The device offers low ON-state resistance and excellent ON-state resistance matching with break-before-make feature, to prevent signal distortion during the transferring of a signal from one channel to another. The device is capable of truly isolation. Even when A overrides VCC, very little current will flow back to the supply.

Features

- \triangleright Low On-resistance, Ron=1.5Ω when A=5V
- ➤ 1.8V Logic Compatible Control Pin
- > A Overrides VCC to Achieve True Isolation Even When Supply Is Dead
- ➤ High Off-Isolation: -100dB @ 100KHz
- Low Channel-to-Channel Crosstalk: -97dB @ 100KHz
- High Bandwidth (-3dB @700MHz) Suitable for USB2.0 High-Speed Routing
- ➤ Low Quiescent Current (<2uA) With Very Wide Supply Range (1.5V ~ 5.5V)
- ➤ ESD HBM: ±5500V
- SC70-6 Package

Applications

- Audio
- Video
- UART
- USB2.0 Signal and Supply Routing
- Cell phones
- > TWS headset

Order Information

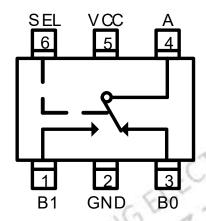
Package		Part Number	Quantity per Reel		
SOT23-6	Tape and Reel	RLCS3457ST6/R6	3,000PCS		

RONIC CO.LTD



Functions and Pin Configuration

Pin Number	Symbol	Descriptions
1	B1	Analog/Digital Signal Port (Normally open)
2	GND	Ground
3	В0	Analog/Digital Signal Port (Normally closed)
4	А	Common Signal Port
5	VCC	Single Power Supply
6	SEL	Logic Input Control



Pin configuration (Top view) SOT23-6

Function Descriptions

Logic Input	Function
S=0	B0=A
S=1	B1=A



Absolute Maximum Ratings (1)

Parameter	Symbol	Value	Unit
Supply Voltage	V_{CC}	-0.3 ~ 6.5	V
Control Input Voltage	V_S	-0.3 ~ 6.5	V
Continuous Current Through A, B0, B1		±100	mA
Peak Current Through A, B0, B1 (pulsed at 1ms 50% duty cycle)		±200	mA
Storage Temperature Range	T_{STG}	-55 ~ 1 50	°C
Junction Temperature under Bias	TJ	150	°C
Lead Temperature (Soldering, 10 seconds)	T _L	260	°C
Thermal resistance	$R_{\theta JA}$	350	°C/W

Recommend operating ratings (2)

Parameter	Symbol	Value	Unit
Supply Voltage Operating	V _{CC}	1.5 ~ 5.5	V
Control Input Voltage	Vs	-0.3 ~ 5.5	V
Input Signal Voltage	V _A	-0.3 ~ 5.5	V
Operating Temperature	T _A	-40 ~ 85	°C

Note:

1. "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied.



DC Electronics Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input logic high lovel	V	VCC: 3.3 ~ 5.5V	1.6			V
Input logic high level	V_{IH}	VCC: 1.5 ~ 3.3V	1.4			V
Input logic low lovel	M	VCC: 3.3 ~ 5.5V			0.6	V
Input logic low level	V_{IL}	VCC: 1.5 ~ 3.3V			0.4	V
Supply quiescent current	lcc	$I_A=0$, $V_S=0$ or $V_S=VCC$			1.0	uA
Increase in I _{CC} per input	Ісст	I _A =0, VCC=4.5V V _S >1.8 or V _S <0.5			1.0	uA
Off state leakage from A to B0 (or B1)	I _A	V _A = 5.5V , V _{B0(or B1)} = 0V			±2.0	uA
	R _{ON1}	V _A =0 ~ 0.5V, I _A =30mA		3.0	3.5	Ω
On-Resistance	R _{ON2}	V _A =0.5 ~ 2.0V, I _A =30mA		3.6	3.9	Ω
OII-Nesistance	R _{ON3}	V _A =2.0 ~ 4.0V, I _A =30mA		2.5	3.5	Ω
	R _{ON4}	V _A =4.0 ~ 5.5V, I _A =30mA		1.5	1.8	Ω
	R _{FLAT1}	V _A =0 ~ 0.5V, I _A =30mA		0.7		Ω
On-Resistance Flatness	R _{FLAT2}	V _A =0.5 ~ 2.0V, I _A =30mA	-01	0.5	10.	Ω
On-Nesistance Hatness	R _{FLAT3}	V _A =2.0 ~ 4.0V, I _A =30mA	600	1.6	7	Ω
	R _{FLAT4}	V _A =4.0 ~ 5.5V, I _A =30mA	1	0.3		Ω
On-Resistance Matching Between Channels	ΔR _{ON}	V _A =0~5.5V, I _A =30mA,	10	0.1	0.2	Ω

AC Electronics Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

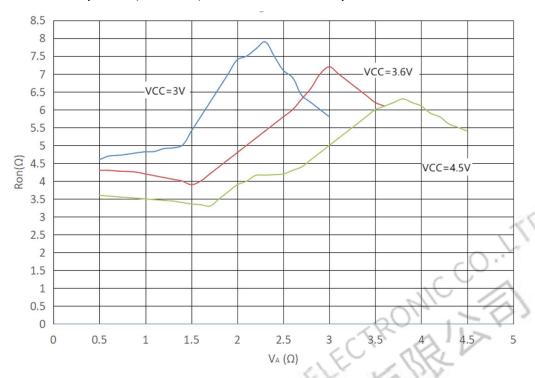
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Turn-On Time	T _{ON}	V _A =1.5V, C _L =35pF, R _L =50Ω		200		ns
Turn-Off Time	T _{OFF}	V _A =1.5V, C _L =35pF, R _L =50Ω		200		ns
Break-Before-Make time	T _{BBM}	V _A =1.5V, C _L =35pF, R _L =50Ω		500		ns
-3dB Bandwidth	BW	R _L =50Ω, C _L =0pF		700		MHz
Off isolation	OIRR	F=1KHz, R _L =50Ω		-81		dB
On isolation	OIKK	F=10KHz, R _L =50Ω		-80		dB
Crosstalk	Xtalk	$F=1$ KHz, $R_L=50Ω$		-83		dB
Crosstalk	Aldik	F=10KHz, R _L =50Ω		-82		dB
Total Harmonic Distortion	THD	F=20Hz to 20KHz V_A =600mVp-p @R _L =32 Ω ,		-80		dB

Capacitance (Ta=25°C unless otherwise noted)

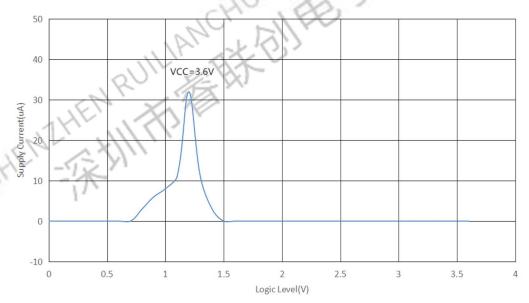
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Off capacitance	C _{OFF}	F=100KHz, VCC=3.3		5		pF
On capacitance	C _{ON}	F=100KHz, VCC=3.3		7		pF



Typical Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)



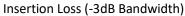
Ron vs. VCC and VA voltage



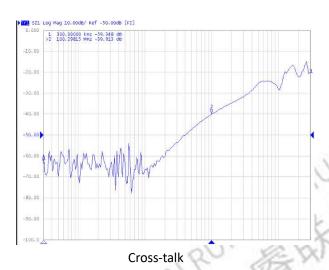
Supply Current vs. Logic Input

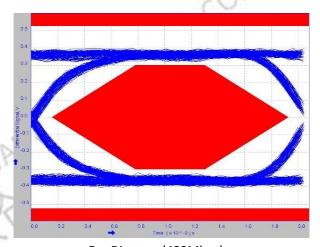








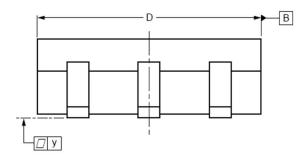


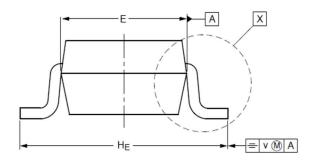


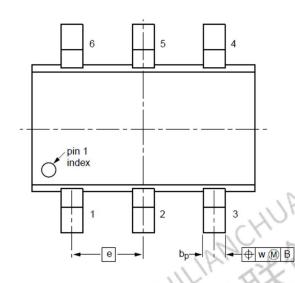
Eye Diagram (480Mbps)

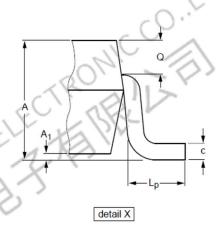


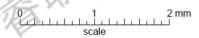
PACKAGE OUTLINE DIMENSIONS











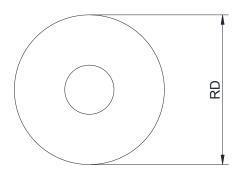
Dimensions (mm are the original dimensions)

U	nit	A	A ₁	bp	С	D	Е	е	HE	Lp	Q	٧	W	у
		1.1	0.1	0.40	0.26	3.1	1.7		3.0	0.6	0.33	0.0	0.0	0.4
mm	nom min	0.9	0.013	0.25	0.10	2.7	1.3	0.95	2.5	0.2	0.23	0.2	0.2	0.1

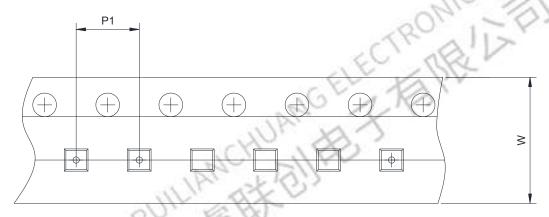


TAPE AND REEL INFORMATION

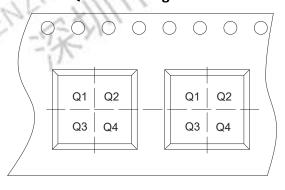
Reel Dimensions



Tape Dimensions



Quadrant Assignments For PIN1 Orientation In Tape





R	Reel Dimension	₹ 7inch	13inch		
W	Overall width of the carrier tape	₹ 8mm	☐ 12mm	☐ 16mm	
P1	Pitch between successive cavity centers	☐ 2mm	✓ 4mm	☐ 8mm	
Pin1	Pin1 Quadrant	₽ Q1	☐ Q2	☐ Q3	☐ Q4



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